PRODUCT SPECIFICATION

PRODUCT SERIES NAME: A1024 SERIES-SMT TYPE

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1.SCOPE:

This specification covers the requirements for product performance of 1.00mm pitch wire to board connector series.

2.CONSTRUCTION · DIMENSIONS · MATERIAL & PLATING:

See the attached drawings

3.RATINGS & APPLICABLE WIRES:

Item	Standard		
Rated Voltage (max.)	50V AC, DC		
Rated Current (max.)	AWG #28	1A AC, DC	Insulation O.D.
and Applicable Wires	AWG #30 1A AC, DC		0.80mm (max.)
	AWG #32	0.8A AC, DC	
Ambient Temperature Range	-25°C ~ +85°C*		

^{*:} Including terminal temperature rise

4.PERFORMANCE:

4-1.ELECTRICAL PERFORMANCE

Test Description		Procedure	Requirement	
4-1-1	Contact	Mate connectors, measure by dry circuit, 20mV max.,	$20 \mathrm{m}\Omega$ max.	
	Resistance	10mA. (Based upon JIS C5402 5.4)	ZUIIISZ IIIAX.	
4-1-2	Insulation Mate connectors, apply 500V DC between adjacent			
	Resistance	terminal or ground. (Based upon JIS C5402 5.2/	$100 \mathrm{M}\Omega$ min.	
		MIL-STD-202 Method 302 Cond. B)		
4-1-3	Dielectric	Mate connectors, apply 500V AC (rms) for 1 minute		
Withstanding		between adjacent terminal or ground. (Based upon	No Breakdown	
Voltage		JIS C5402 5.1/MIL-STD-202 Method 301)		
4-1-4	Contact	Crimp the applicable wire on to the terminal, measure		
	Resistance	Resistance by dry circuit, 20mV max., 10mA.		
	on Crimped		$5m\Omega$ max.	
	Portion			

			APPROVED	CHECKED	WRITTEN
			BY	BY	BY
			唐飞	李强	周新宇
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4-2.MECHANICAL PERFORMANCE

Test Description		Procedure		Requirement	
4-2-1	Insertion & Withdrawal Force	Insert and withdraw connectors at the sp 25 ± 3 mm/minute.	Refer to paragraph 5		
4-2-2	Crimping	Fix the crimped terminal, apply axial pull out force on the wire at the speed	AWG #28	1.0kgf min.	
	Pull Out Force	rate of 25 ± 3mm/minute. (Based upon JIS C5402 6.8)	AWG #30	0.5kgf min.	
			AWG #32	0.3kgf min.	
4-2-3	Terminal Insertion Force	Insert the crimped terminal into the hous	0.5kgf max.		
4-2-4	Terminal/ Housing Retention Force	Apply axial pull out force at the speed ra 25 ± 3 mm/minute on the terminal assem housing.	0.5kgf min.		
4-2-5	Pin Retention Force	Apply axial push force at the speed rate 25 ± 3 mm/minute.	0.3kgf min.		
4-2-6	Durability	When mated up to 50 cycles repeatedly Contact by the rate of 10 cycles per minute. Resistance		40mΩ max.	
		Amplitude: 1.5mm P-P Sweep time: 10-55-10 Hz in 1 minute	Appearance	No Damage	
4-2-7	Vibration	Duration: 2 hours in each X.Y.Z. axes (Based upon MIL-STD-202 Method 201A)	Contact Resistance	40m $Ω$ max.	
			Discontinuity	1μsec. max.	
		490m/s² {50G}, 3 strokes in each X.Y.Z. axes.	Appearance	No Damage	
4-2-8	Physical Shock		Contact Resistance	40m $Ω$ max.	
			Discontinuity	1μsec. max.	

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4-3.ENVIRONMENTAL PERFORMANCE AND OTHERS

Test Description		Procedure		Requirement	
		Carrying rated current load.	Temperature	30°C max.	
Rise		(Based upon UL 498)	Rise	JO C IIIax.	
4-3-2	Heat	85 ± 2 °C, 96 hours	Appearance	No Damage	
	Resistance	(Based upon JIS C0021/MIL-STD-202	Contact	$40 \mathrm{m}\Omega$ max.	
		Method 108A Cond. A)	Resistance	40IIISZ IIIGA.	
4-3-3	Cold	-25 ± 3 °C, 96 hours	Appearance	No Damage	
	Resistance	(Based upon JIS C0020)	Contact	$40 \mathrm{m}\Omega$ max.	
			Resistance		
		Temperature: $40 \pm 2^{\circ}$ C	Appearance	No Damage	
		Relative Humidity: 90 ~ 95%	Contact	$40 \mathrm{m}\Omega$ max.	
		Duration: 96 hours	Resistance	TOTAL THUX.	
4-3-4	Humidity	(Based upon JIS C0022/MIL-STD-202	Insulation	$10 \mathrm{M}\Omega$ min.	
		Method 103B Cond. B)	Resistance	1014122 111111.	
			Dielectric		
			Withstanding	Must meet 4-1-3	
			Voltage		
		5 cycles of:	Appearance	No Damage	
4-3-5	Temperature		прреаганее	110 Damage	
	Cycling	b) +85°C 30 minutes	Contact	$40 \mathrm{m}\Omega$ max.	
		(Based upon JIS C0025)	Resistance	TOINS2 Max.	
		48 ± 4 hours exposure to a salt spray	Appearance	No Damage	
4-3-6	Salt Spray	from the $5 \pm 1\%$ solution at 35 ± 2 °C. (Based upon JIS C0023/MIL-STD-202	пррешинее	110 Damage	
			Contact	$40 \mathrm{m}\Omega$ max.	
		Method 101D Cond. B)	Resistance		
	SO ₂ Gas	24 hours exposure to 50 ± 5 ppm. SO ₂ gas at 40 ± 2 °C.	Appearance	No Damage	
4-3-7			Contact	$40\mathrm{m}\Omega$ max.	
			Resistance		
		40 minutes exposure to NH ₃ gas	Appearance	No Damage	
4-3-8	NH ₃ Gas	evaporating from 28% Ammonia	Contact	$40 \mathrm{m}\Omega$ max.	
		solution.	Resistance		
		Soldering Time: 5 ± 0.5 sec.	Solder	95% of immersed	
4-3-9	Solderability	Solder Temperature: 245 ± 5 °C	Wetting	area must show no	
				voids, pin holes	
		When reflowing			
4-3-10	Resistance	Refer to paragraph 6			
	to Soldering		Appearance	No Damage	
	Heat	Solder iron method	Appearance	No Damage	
		Soldering Time: 5 ± 0.5 sec.			
		Solder Temperature: 370°C ~ 400°C			

PRODUCT SPECIFICATION

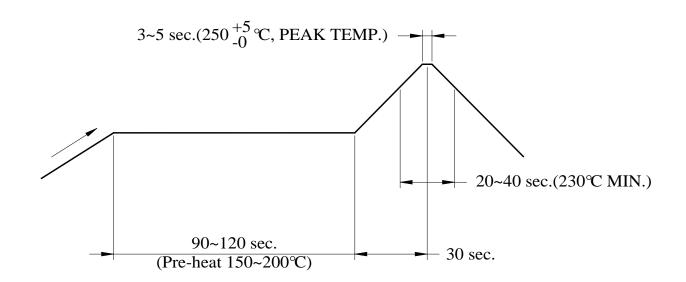
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5.INSERTION/WITHDRAWAL FORCE:

No. of	Insertion	Withdrawal	No. of	Insertion	Withdrawal
circuits	(kgf max.)	(kgf min.)	circuits	(kgf max.)	(kgf min.)
single	0.2	0.03	15	3.4	0.75
2	0.8	0.10	16	3.6	0.80
3	1.0	0.15	17	3.8	0.85
4	1.2	0.20	18	4.0	0.90
5	1.4	0.25	19	4.2	0.95
6	1.6	0.30	20	4.4	1.00
7	1.8	0.35			
8	2.0	0.40			
9	2.2	0.45			
10	2.4	0.50			
11	2.6	0.55			
12	2.8	0.60			
13	3.0	0.65			
14	3.2	0.70			

6.INFRARED REFLOW CONDITION:



TEMPERATURE CONDITION GRAPH (TEMPERATURE ON BOARD PATTERN SIDE)

NOTE: Please check the mount condition(reflow soldering condition) by your own devices beforehand, because the condition changes by the soldering devices, p.c.boards, and so on. No moisture treatment before reflow process.